

Specification for TFT

AFY800480B1-7.0N12NTM





А	Orient Display
FY	ТFT Туре
800480	Resolution 800 x 480
B1	Serial B1
7.0	7.0'', Module Dimension 164.90 x 100.00 x 3.50 mm
Ν	TN Display
12	12 o'clock
Ν	Top: -30~+70°C; Tstr: -30~+80°C
Т	Transmissive
Μ	Medium Brightness, 520cd/m2
/	Controller EK9716B+ EK73002AB2
/	24bits RGB Interface













REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
Ο	2015-08-03	First release	Preliminary
А	2015-08-26	Update drawing	Page 5
В	2015-09-10	Change the driver IC	Page 4
С	2016-02-20	Update the TBD data	Page4,6
D	2016-07-26	Revise the interface description	Page9
E	2020-09-11	Update panel and IC and optical	Page4,5,6

CONTENTS

1. GENERAL INFORMATION	4
2.ABSOLUTE MAXIMUM RATINGS	4
3. ELECTRICAL CHARACTERISTICS	4
4. BACKLIGHT CHARACTERISTICS	4
5. EXTERNAL DIMENSIONS	5
6. ELECTRO-OPTICAL CHARACTERISTICS	6
7. INTERFACE DESCRIPTION	9
8. AC CHARACTERISTICS	10
9.POWER SEQUENCE	12
10. RELIABILITY TEST CONDITIONS	12
11. INSPECTION CRITERION	14
12. HANDLING PRECAUTIONS	17
13. PRECAUTION FOR USE	18
14. PACKING SPECIFICATION	

1. GENERAL INFORMATION

No.	ltem	Contents	Unit
1	LCD size	7.0 inch (Diagonal)	/
2	LCD type	TN/Normally white/Transmissive (Anti-glare)	/
3	Viewing direction(eye)	12 O' clock	/
4	Gray scale inversion direction	6 O' clock	/
5	Resolution(H*V)	800*480	/
6	Module size (L*W*H)	164.9*100.0*3.5	mm
7	Active area (L*W)	153.84*85.63	mm
8	Pixel pitch (L*W)	0.1923*0.1784	mm
9	Interface type	RGB Interface	/
10	Module power consumption	0.462(Without backlight)	W
11	Back light type	LED	/
12	Driver IC	EK9716BD4+EK73002AB2 OR COMPATIBLE	/
13	Weight	122.2	g

2. ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Min	Max	Unit
Power supply input voltage (LCM)	VDD	-0.5	5.0	V
Backlight current (normal temp.)	ILED	-	75	mA
Operation temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C
Humidity	RH	-	90%(Max60°C)	RH

3. ELECTRICAL CHARACTERISTICS DC CHARACTERISTICS (at Ta=25°C)

Item	Symbol	Min	Тур	Max	Unit	Note
Power supply input voltage (LCM)	VDD	2.7	3.3	3.6	V	
I/O logic voltage	VDDIO	N/A	N/A	N/A	V	
Input voltage 'H' level	VIH	0.7VDD	-	VDD	V	
Input voltage 'L' level	VIL	0	-	0.3VDD	V	
Power supply current	IVDD	-	140	-	mA	
TFT gate on voltage	VGH	-	18	-	V	
TFT gate off voltage	VGL	-	-8	-	V	
Analog power supply voltage	AVDD	-	10.3	-	V	
Differential input common mode voltage	Vcom	-	3.4	-	V	

4. BACKLIGHT CHARACTERISTICS

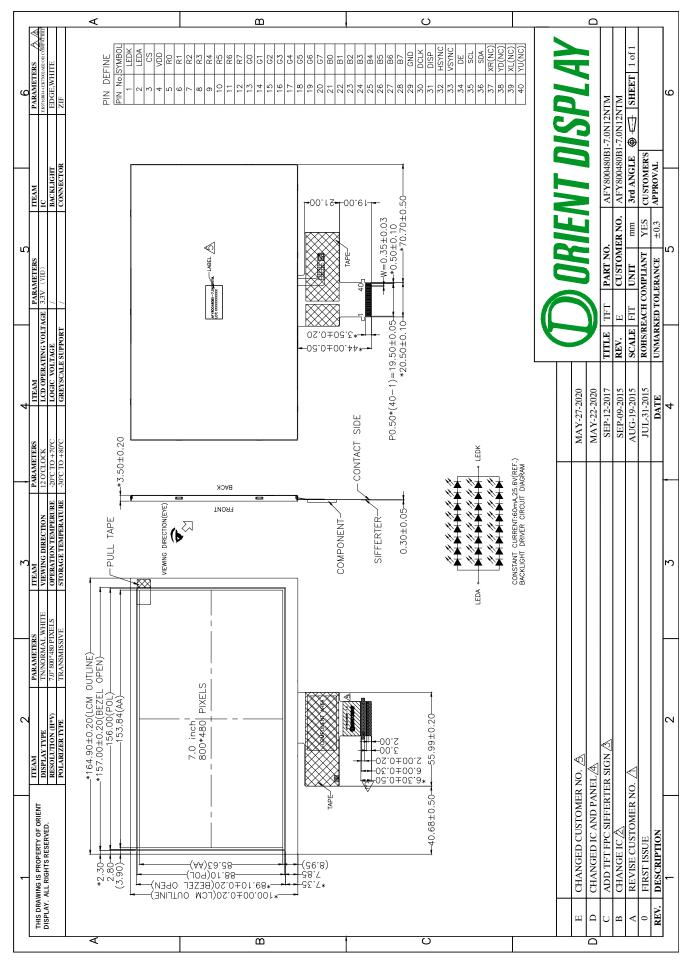
(at Ta=25°C,RH=60%)

Item	Symbol	Min.	Тур.	Max.	Unit	Note
LED forward voltage	VF	-	25.6	-	V	IF=60mA
LED forward current	IF	-	60	-	mA	
LED power consumption	PLED	-	1.536	-	W	Note1
Number of LED	-		24		PCS	
Connection mode	-	8 in se	ries *3 in par	allel	/	
LED life-time	-	20000	-	-	Hrs	Note2

Note1.Calculator Value for reference: IF*VF = PLED

Note2.The LED Life-time define as the estimated time to 50% degradation of initial brightness at Ta= 25° C and IF =60mA. The LED lifetime could be decreased if operating IF is larger than 60mA

5. EXTERNAL DIMENSIONS



ltem	Symbol	Condition	Min	Тур	Max	Unit	Remark	Note
Response time	Tr+ Tf		-	25	50	ms	FIG.1	Note 4
Contrast ratio	Cr	-	400	500	-		FIG.2	Note 1
Surface Luminance	Lv	θ=0°	420	520	-	cd/m ²	FIG.2	Note 2
Luminance uniformity	δ WHITE	θ=0°	60	75	-	%	FIG.2	Note 3
NTSC	-	θ=0 °	-	50	-	%	FIG.2	Note 5
		Ø = 90°	60	70	-	deg	FIG.3	
	0	Ø = 270°	50	60	-	deg	FIG.3	Nata C
viewing angle	ewing angle θ		60	70	-	deg	FIG.3	Note 6
		Ø = 180°	60	70	-	deg	FIG.3	
	Red x		0.5378	0.5778	0.6178	-		
	Red y		0.2872	0.3272	0.3672	-		
	Green x	0.00	0.3128	0.3528	0.3928	-		
CIE (x, y)	Green y	θ=0°	0.5548	0.5948	0.6348	-	FIG.2	Niete C
chromaticity	Blue x	Ø=0° Ta=25° C	0.1140	0.1540	0.1940	-	CIE1931	Note 5
	Blue y	1a-25 C	0.0977	0.1377	0.1777	-]	
	White x		0.2685	0.3085	0.3485	-]	
	White y		0.3189	0.3589	0.3989	-		

Note1.Definition of contrast ratio

Contrast Ratio(CR) is defined mathematically by the following formula. For more information see FIG.2 <u>Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5, P6, P7, P8, P9)</u>

Contrast Ratio = Average Surface Luminance with all black pixels (P1, P2, P3, P4, P5, P6, P7, P8, P9) Note2.Definition of surface luminance

Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG.2

Lv = Average Surface Luminance with all white pixels(P1, P2, P3, P4, P5, P6, P7, P8, P9)

Note3.Definiton of luminance uniformity

The luminance uniformity in surface luminance (δ WHITE) is determined by measuring luminance at each test position 1 through 9, and then dividing the maximum luminance of 9 points luminance by minimum luminance of 9 points luminance. For more information see FIG.2

Yu= Minimum Surface Luminance with all white pixels (P1, P2, P3, P4, P5,P6,P7,P8,P9) Maximum Surface Luminance with all white pixels (P1, P2, P3, P4, P5,P6,P7,P8,P9)

Note4. Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black"state.Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.For additional information see FIG1.

Note5. Definition of color chromaticity (CIE1931)

CIE (x, y) chromaticity ,The x,y value is determined by screen active area center position P5,For more information see FIG.2

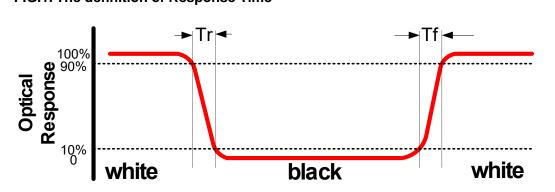
Note6. Definition of Viewing angle

Viewing angle is the angle at which the contrast ratio is greater than 10. angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG.3

For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope or DMS series Instruments or compatible. For contrast ratio, Surface Luminance, Luminance uniformity and CIE, the testing data is base on TOPCON's BM-5 or BM-7 photo detector or compatible.

Note: For TFT module, Gray scale reverse occurs in the direction of panel viewing angle.

FIG.1. The definition of Response Time





Size:S≤5"(see Figure a)

A : 5 mm B : 5 mm

H,V : Active Area

Light spot size ∅=5mm(BM-5) or ∅=7.7

(BM-7)50cm distance or

compatible distance from the LCD surface to detector lens.

test spot position: see Figure a.

measurement instrument : TOPCON's luminance meter BM-5 or

BM-7 or compatible (see Figure c)

Size:5"<S≤12.3"(see Figure b) H,V : Active Area

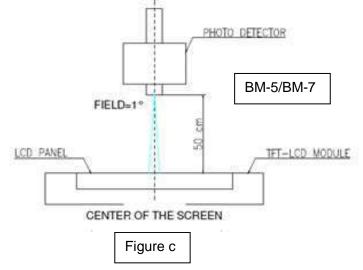
Light spot size \varnothing =5mm(BM-5) or \varnothing =7.7mm (BM-7)50cm distance or

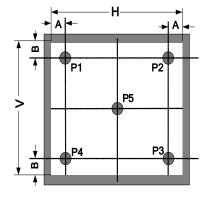
compatible distance from the LCD surface to detector lens

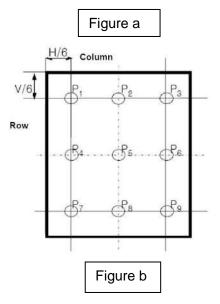
test spot position: see Figure b

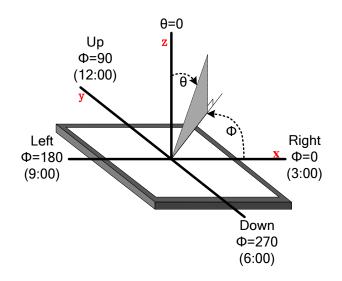
measurement instrument : TOPCON's luminance meter BM-5 or

BM-7 or compatible (see Figure c)









7. INTERFACE DESCRIPTION

LCM Interface	descriptio	<u>pn</u>	
Interface No.	Name	I/O or connect to	Description
1	LEDK	Р	Power for LED backlight(Cathode)
2	LEDA	Р	Power for LED backlight(Anode)
3	CS	1	SPI function chip select signal
4	VDD	Р	Digital Power
5-12	R0-R7	1	Red data
13-20	G0-G7	1	Green data
21-28	B0-B7	1	Blue data
29	GND	Р	Power Ground
30	DCLK	1	Clock input
31	DISP	I	Display on/off
32	HSYNC	1	Horizontal sync input. Negative polarity
33	VSYNC	1	Vertical sync input. Negative polarity
34	DE	1	Data Enable signal ;normally pull low
35	SCL	I	SPI SCL function
36	SDA	1	SPI SDA function
37	XR(NC)	/	1
38	YD(NC)	/	1
39	XL(NC)	/	1
40	YU(NC)	/	1

8. AC CHARACTERISTICS

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
VDD Power On Slew rate	TPOR	From 0V to 90% VDD			20	ms
RSTB pulse width	TRST	CLKIN = 50MHz	50	2376	-	us
CLKIN cycle time	Tcph		20)(• :)	•	AS
CLKIN pulse duty	Towh	8 4 87	40	50	60	8
VSD setup time	Tvst	15-11 15-11	8	Y%\$	110 -	121
VSD hold time	Tvhd	173	8	- (741	Ins
HSD setup time	Thst	(*)	8	6	121	ns.
HSD hold time	Thhd	(#))	8	11-1	Il S	ns
Data set-up time	Tdsu	DR[7:0], DG[7:0], DB[7:0] to CLKIN	08/1	14	1-1	05
Data hold time	Tdhd	DR[7:0], DG[7:0], DB[7:0] to CLKIN	180	1-1	1-1	AD
DEN setup time	Tesu	- ~ ~	18	A.	1.1	en/l
DEN hold time	Tehd	- 000	18	111	MA	ns
Output stable time	Tsst	10% to 90% target voltage CL=120pF, R=10K of the	H	MU.	6	us

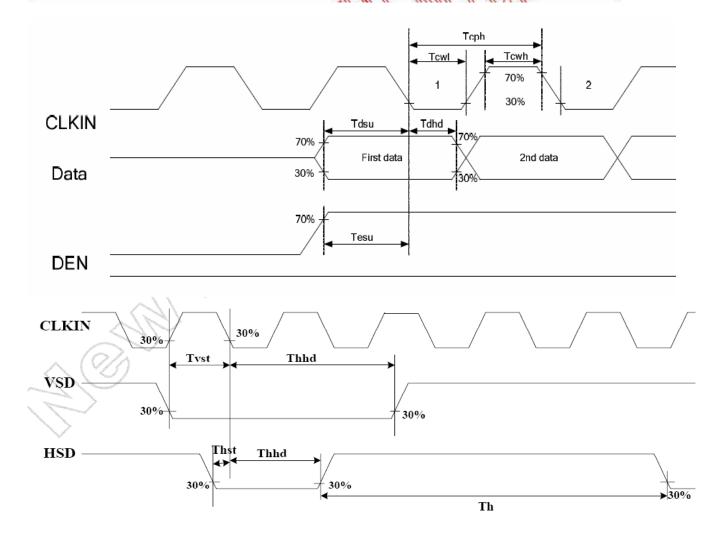
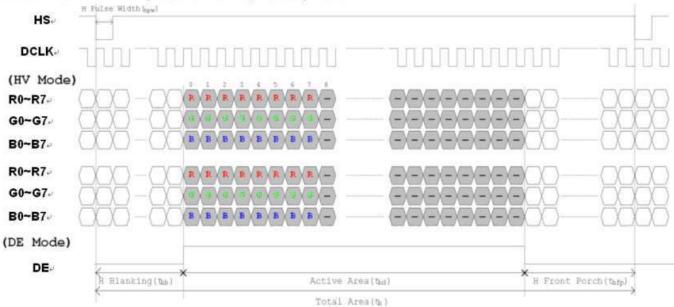


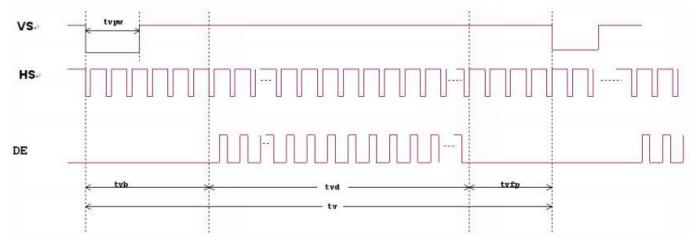
Table 18. Horizontal input timing

Parameter	Symbol		Value		Unit	Note
Horizontal display area	thd		800		DCLK	
DCLK frequency	fclk	Min.	Typ.	Max		
DOLK irequency	ICIN	20	33.3	50	MHz	~
1 Horizontal Line	th	908	928	1088	1	thb+thpw=88
HSD pulse width	thpw	1	48	87	DCLK	DOLRIS
HSD Back Porch (Blanking)	thb	87	40	1		fixed
			1.4		-	I THE ME
HSD Front Porch	thfp	20	40	200	06	All all
	thfp Symbol	20 Min.	40 Typ.	200	Unit	Note
Table 19. Vertical input timing Parameter					Unit	Note
Table 19. Vertical input timing	Symbol		Тур.		Unit	1 De
Table 19. Vertical input timing Parameter Vertical display area	Symbol tvd	Min.	Typ. 480	Max.	A	typy+tyb=32H
Table 19. Vertical input timing Parameter Vertical display area VSD period time	Symbol tvd tv	Min.	Typ. 480	Max.	H.	1 De

Horizontal input timing diagram.

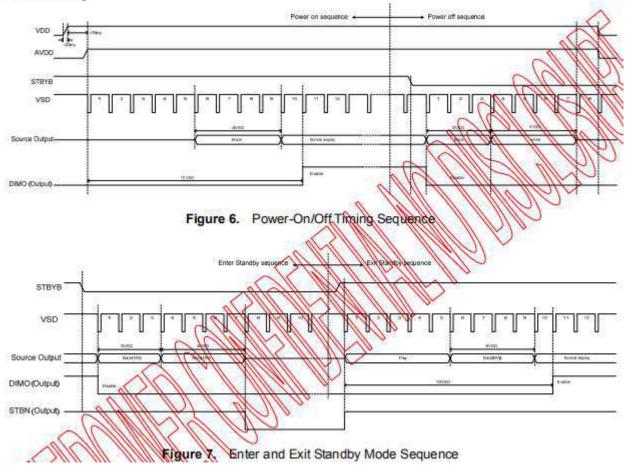


Vertical input timing diagram.



9. POWER SEQUENCE

In order to prevent IC from power on reset fail, the rising time (T_{POR}) of the digital power supply VDD should be maintained within the given specifications. Refer to "AC Characteristics" for more detail on timing.



10.RELIABILITY TEST CONDITIONS

No.	Test Item	Test Condition	Inspection after test	
1	High Temperature Storage	80±2℃/240 hours		
2			Inspection after	
3	High Temperature Operating	70±2℃/120 hours	2~4hours storage at	
4	Low Temperature Operating	-20±2°C/120 hours	room temperature, the sample shall be free	
5	Temperature Cycle	-20±2℃~25~70±2℃*10cycles (30min.) (5min.) (30min.)	from defects: 1.Current changing	
6	Damp Proof Test			
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz Amplitude: 1.5mm, X, Y, Z direction for total 3hours (Packing condition)	after test is 50% larger; 2. function defect: Non-display ,abnormal-d isplay, missing lines,	
8	Dropping test	Drop to the ground from 1m height, one time, every side of carton. (Packing condition)	Short lines, ITO corrosion; 3.visual defect: Air	
9	ESD test	Voltage:±8KV R: 330Ω C: 150pF Air discharge, 10time	bubble in the LCD, Seal leak, Glass crack。	

Remark:

1. The test samples should be applied to only one test item.

2.Sample size for each test item is 3~5pcs.

3.For Damp Proof Test, Pure water(Resistance > $10M\Omega$) should be used.

4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

5.EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has. 6.Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

11. INSPECTION CRITERION

11.1 Description

This specification is made to be used as the standard acceptance/rejection criteria for TFT LCM Product.

1.Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65

Minor defect: AQL 1.5

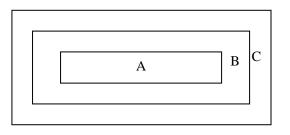
2. Inspection condition

•Viewing distance for cosmetic inspection is about 30±5cm with bare eyes, and under an environment 600~1000lux for visual inspection and 0~200lux for function test., all directions for inspecting the sample should be within 45° against perpendicular line. (Normal temperature 18~28°C and normal humidity 60±15%RH).

Driving voltage

The Vop value from which the most optical contrast can be obtained near the specified Vop in the specification (Within $\pm 0.5V$ of the typical value at 25°C.).

3. Definition of inspection zone in LCD



Zone A: character/Digit area

Zone B: viewing area except Zone A (Zone A+Zone B=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

11.2 Inspection criterion

Items to be inspected	Inspection criterion	Classification of defects
All functional defects	 No display Display abnormally Missing vertical, horizontal segment Short circuit Back-light no lighting, flickering and abnormal lighting. obvious striation Current beyond specification value 	MA
Missing	Missing component	
Outline dimension	Overall outline dimension exceed the drawing is not allowed.	

11.2.2 LCD pixel defect (bad dot) (defect type:MI)

Checking item	Judgment criterion		
Item/LCD size	S ≤5.0 Inch	5.0 <s≤7.0 inch<="" th=""><th>7<s≤12.3 inch<="" th=""></s≤12.3></th></s≤7.0>	7 <s≤12.3 inch<="" th=""></s≤12.3>

Color bad dot-bright dot(R、G、B)	1	2	3
two adjacent bright point	0	1	2
three or more adjacent point	0	0	0
total points for bad dot-bright dot	1	2	5
Bad dot-dark dot	2	4	5
two adjacent dark point	1	2	3
three or more adjacent point	0	1	1
total points for bad dot -dark dot	3	6	7
patch bright dot	Invisible with ND5 % ,it is OK.		

11.2.3 dot and line defect (defect type:MI)

Checking	Judgment criterion			- '		
item	Diameter(mm)\LCD Size		S ≤5.0 Inch	5 <s≤7 inch<="" th=""><th>7<s≤12.3 inch<="" th=""><th>Figure</th></s≤12.3></th></s≤7>	7 <s≤12.3 inch<="" th=""><th>Figure</th></s≤12.3>	Figure
Dot defect	D≤0.1		allowed	allowed	allowed	
	0.1 <d≤0.2< td=""><td></td><td>4</td><td>allowed</td><td>allowed</td><td></td></d≤0.2<>		4	allowed	allowed	
	0.2 <d≤0.3< td=""><td></td><td>0</td><td>5</td><td>6</td><td>16</td></d≤0.3<>		0	5	6	16
Dol delect	0.3 <d≤0.5< td=""><td></td><td>0</td><td>0</td><td>0</td><td></td></d≤0.5<>		0	0	0	
	D>0.5		0	0	0	D=(a+b)/2
	the distance	between the tw	vo defect dot:D)S≥5mm		
	Length(mm)	width(mm)		Judgment crite	erion	
line defect	disregard	W≤0.05	allowed	allowed	allowed	<u>↓</u>
line defect	L≤5	0.05 <w≤0.1< td=""><td>4</td><td>5</td><td>7</td><td>\sim</td></w≤0.1<>	4	5	7	\sim
	L>5	W>0.1	0	0	0	
Concave	LCD Size(mm)		Judgment criterion			
point and	D≤	≦0.3	allowed	allowed	allowed	
air bubble	0.3<	D≤1.0	3	4	5	
for	1.0<	CS1.5	1	2	3	i a i
polarizer	D>1.5		0	0	0	D=(a+b)/2
	Length (mm)	width (mm)		Judgment cri	terion	
	disregard	W≤0.05	allowed	allowed	allowed	
Fold mark,	1 <l≤5< td=""><td>0.05<w≤0.2< td=""><td>3</td><td>4</td><td>5</td><td></td></w≤0.2<></td></l≤5<>	0.05 <w≤0.2< td=""><td>3</td><td>4</td><td>5</td><td></td></w≤0.2<>	3	4	5	
linear scar	L>5	W>0.2	0	0	0	
for polarizer Notes:1.If the fold m defect is judged with						

with non-operating condition, the defect is judged with the above judgment standard.

11.2.4 Corner and others crack for LCD (defect type:MI)

Checking item	Judgment criterion	Figure
electric conduction crack	X≤3.0mm,Y≤1/4w,Z≤t,N≤2	V TTANA 2

Checking item	Judgment criterion	Figure
corner crack	X≤3.0mm,Y≤3.0mm,Z≤t,N≤3 Corner crack extended to ITO PIN,none allowed	
surface crack	X≤1.5mm,Y≤1.0mm, Z≤t, N≤4	Z Z Z Z Z Z Z Z Z Z Z Z Z Z Z Z Z Z Z

11.2.5 Module Cosmetic Criteria (defect type:MI)

ltem	Judgment Criterion		
Difference in Spec.	None allowed		
Pattern peeling	No substrate pattern peeling and floating		
Soldering defects	No soldering missing No soldering bridge No cold soldering		
	Notes: detail judgment referring to IPC-A-610 grade ${f I}$		
Resist flaw on Printed Circuit Boards	visible copper foil (¬0.5mm or more) on substrate pattern, none allowed		
Accretion of metallic Foreign matter	No accretion of metallic foreign matters (Not exceed ¬0.2mm)		
Stain	No stain to spoil cosmetic badly		
Plate discoloring	No plate fading, rusting and discoloring		
Newton ring	Referring to limited sample		
Mura	Invisible with 5%ND,allowed		
Light leaks	Referring to limited sample		

12. HANDLING PRECAUTIONS

12.1 Mounting method

The LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board. Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[recommended below] and wipe lightly

- •.lsopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent:

Water

Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns

Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- •.Chlorine (Cl) , Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

12.4 Packing

Module employ LCD elements and must be treated as such.

•. Avoid intense shock and falls from a height.

•.To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

•. It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.

•. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.

•.Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.

•. If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.

•.A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.

12.6 Storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

•.Storing in an ambient temperature 10°C to 30°C, and in a relative humidity of 45% to 75%. Don't expose to sunlight or fluorescent light.

•.Storing in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it . And with no desiccant.

•.Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.

•.Storing with no touch on polarizer surface by the anything else.

It is recommended to store them as they have been contained in the inner container at the time of delivery from us.

12.7 Safety

•.It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.

•. When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. PRECAUTION FOR USE

13.1 A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2 On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

•.When a question is arisen in this specification

•.When a new problem is arisen which is not specified in this specifications

•.When an inspection specifications change or operating condition change in customer is reported to ODNA, and some problem is arisen in this specification due to the change

•.When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. PACKING SPECIFICATION

Please consult our technical department for detail information.